MIL-PRF-38534 CERTIFIED FACILITY

HIGH CURRENT, LOW DROPOUT VOLTAGE REGULATORS

FEATURES:

Electrically Isolated Top Tab or Z Tab SIP

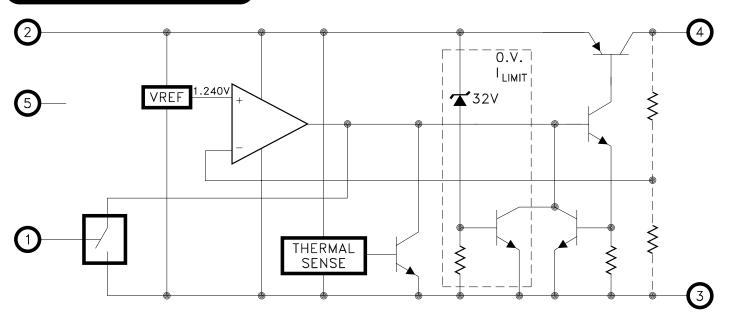
TM Technologies

- Extremely Low Dropout Voltage: 350mV @ 1.5 Amps
- Available in +1.5V,+1.7V,+1.9V,+2.5V,+3.3V,+5.0V and +12.0V
- TTL Level Enable Pin: Zero Current Shutdown Mode
- Reverse Battery and Load Dump Protection
- Low Ground Current: 32mA Typical at Full Load
- 1% Maximum Guaranteed Accuracy
- Output Current to 1.5 Amps

DESCRIPTION:

The MSK5116 series voltage regulators are available in +1.5V,+1.7V,+1.9V,+2.5V,+3.3V,+5.0V and +12.0V configurations. All boast ultra low dropout specifications due to the utilization of a super PNP output pass transistor with monolithic technology. Dropout voltages of 350mV at 1.5 amps are typical in this configuration, which drives efficiency up and power dissipation down. Accuracy is guaranteed with a 1% maximum output voltage tolerance. The series also offers a TTL/CMOS compatible on/off enable function. The MSK5116 series is packaged in a space efficient 5 pin power SIP available in two styles with three lead bend options.

EQUIVALENT SCHEMATIC

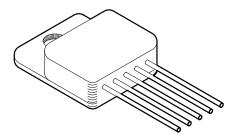


TYPICAL APPLICATIONS

- · High Efficiency, High Current Linear Regulators
- Constant Voltage/Current Regulators
- System Power Supplies
- Switching Power Supply Post Regulators
- Battery Powered Equipment

PIN-OUT INFORMATION

- 1 ENABLE
- 2 VIN
- 3 GROUND
- 4 VOUT
- 5 NC
- CASE = ISOLATED





ABSOLUTE MAXIMUM RATINGS

Vinp	Input Voltage (100mS 1%D.C.)	20V to +60V
Vin	Input Voltage	26V
VEN	Enable Voltage	0.3V to 26V
IOUT	Output Current	3.5A

(9)

TST Storage Temperature Range	65°C to +150°C
TLD Lead Temperature	
(10 Seconds Soldering)	300°C
TC Case Operating Temperature Range	
MSK5116 Series	40°C to +85°C
MSK5116H Series	55°C to +125°C
ESD Rating	Class 1B

ELECTRICAL SPECIFICATIONS

Parameter	Test Conditions ① ③		Group A	MSK5116H SERIES			MSK5116 SERIES			Units
			Subgroup	Min.	Тур.	Max.	Min.	Тур.	Max.	Units
Output Voltage Tolerance	Iout = 10mA; VIN = VOUT +1V		1	-	±0.5	±1.0	-	±0.5	±1.0	%
Output voltage Tolerance			2, 3	-	±1.0	±2.0	-	-	-	%
Dropout Voltage (2) —	ΔVουτ = -1%; Ιουτ = 100mA		1	-	80	200	-	80	225	mV
	ΔVουτ = -1%; Ιουτ = 1.5Α		1	-	350	600	-	350	625	mV
Land Degulation	VIN = VOUT+5V		1	-	±0.2	±1.0	-	±0.2	±1.2	%
Load Regulation (8)	10mA ≤ Iou⊤ ≤ 1.25A	2, 3	-	±0.3	±2.0	-	±0.3	-	%	
Line Degulation	$(VOUT + 1V) \le VIN \le 2$	6V	1	-	±0.05	±0.5	-	±0.05	±0.6	%
Line Regulation	IOUT = 10mA		2, 3	-	±0.5	±1.0	-	±0.5	-	%
Output Current Limit 2	VOUT = 0V; VIN = VOUT	-+1V	-	-	2.1	3.5	-	2.1	3.5	А
Cround Current	VIN = VOUT+1V; IOUT = 0.75A		-	-	18	30	-	18	30	mA
Ground Current 2 —	VIN = VOUT+1V; IOUT = 1.5A		-	-	32	-	-	32	-	mA
Output Noise 2	CL = 10µF; 10Hz ≤ f ≤ 100	0KHz	-	-	400	-	-	400	-	μV
Enable Input Voltage (2)		HIGH/ON	1	2.4	1.2	-	2.4	1.2	-	V
		LOW/OFF	1	-	1.2	0.8	-	1.2	0.8	V
Enable Innut Current		HIGH/ON	1	-	100	600	-	20	600	μA
Enable Input Current (2)		LOW/OFF	1	-	-	2	-	-	2	μA
Shutdown Output Current 2	VENABLE ≤ 0.8V		-	-	10	500	-	10	500	μA
Thermal Resistance 2	Junction to Case @ 125	5°C	-	-	3.1	3.6	-	3.1	3.7	°C/W
Thermal Shutdown 2	TJ		-	-	130	-	-	130	-	°C

NOTES:

(1) Output decoupled to ground using 33µF minimum capacitance unless otherwise specified.

This parameter is guaranteed by design but need not be tested.
Typical parameters are representative of actual device performance but are for reference only.

- (3) All output parameters are tested using a low duty cycle pulse to maintain T_J = Tc.
- (4) Industrial devices shall be tested to subgroup 1 unless otherwise specified.
- (5) Military grade devices ('H' suffix) shall be 100% tested to subgroups 1,2,3.

Subgroup 1 Tc = +25°C
Subgroup 2 TJ = +125°C
Subgroup 3 TA = -55°C

- Please consult the factory if alternate output voltages are required.
- (8) Due to current limit, maximum output current may not be available at all values of VIN-VOUT and temperatures. See typical performance curves for clarification.
- (9) Continuous operation at or above absolute maximum ratings may adversely effect the device performance and/or life cyle.
- (10) Internal solder reflow temperature is 180°C, do not exceed.

APPLICATION NOTES

REGULATOR PROTECTION

The MSK5116 series is fully protected against reversed input polarity, overcurrent faults, overtemperature conditions (Pd) and transient voltage spikes of up to 60V. If the regulator is used in dual supply systems where the load is returned to a negative supply, the output voltage must be diode clamped to ground.

OUTPUT CAPACITOR

The output voltage ripple of the MSK5116 series voltage regulators can be minimized by placing a filter capacitor from the output to ground. The optimum value for this capacitor may vary from one application to the next, but a minimum of 10μ F is recommended for optimum performance. This capacitor need not be an expensive low ESR type: aluminum electrolytics are adequate. In fact, extremely low ESR capacitors may contribute to instability. Tantalum capacitors are recommended for systems where fast load transient response is important. Transient load response can also be improved by placing a capacitor directly across the load.

LOAD CONNECTIONS

In voltage regulator applications where very large load currents are present, the load connection is very important. The path connecting the output of the regulator to the load must be extremely low impedance to avoid affecting the load regulation specifications. Any impedance in this path will form a voltage divider with the load.

ENABLE PIN

The MSK5116 series of voltage regulators are equipped with a TTL compatible ENABLE pin. A TTL high level on this pin activates the internal bias circuit and powers up the device. A TTL low level on this pin places the controller in shutdown mode and the device draws approximately 10μ A of quiescent current. If the enable function is not used, simply connect the enable pin to the input.

DEVICE/CASE CONNECTION

The MSK5116 series are highly thermally conductive devices and the thermal path from the package heat sink to the internal junctions is very short. Since the case is electrically isolated from the internal circuitry, the package can be directly connected to a heat sink.

HEAT SINK SELECTION

To select a heat sink for the MSK5116, the following formula for convective heat flow may be used.

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Governing Equation:
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Tj = Pd x (R θ jc + R θ cs + R θ sa) + Ta

WHERE:

Tj = Junction Temperature Pd = Total Power Dissipation $R\theta_{jc}$ = Junction to Case Thermal Resistance $R\theta_{cs}$ = Case to Heat Sink Thermal Resistance $R\theta_{sa}$ = Heat Sink to Ambient Thermal Resistance Ta = Ambient Temperature

First, the power dissipation must be calculated as follows:

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Power Dissipation = (VIN - VOUT) x lout
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Next, the user must select a maximum junction temperature. The absolute maximum allowable junction temperature is 125° C. The equation may now be rearranged to solve for the required heat sink to ambient thermal resistance (R θ sa).

EXAMPLE:

An MSK5116-3.3 is configured for VIN=+5V and VOUT=+3.3V. lout is a continuous 1A DC level. The ambient temperature is +25°C. The maximum desired junction temperature is 125°C.

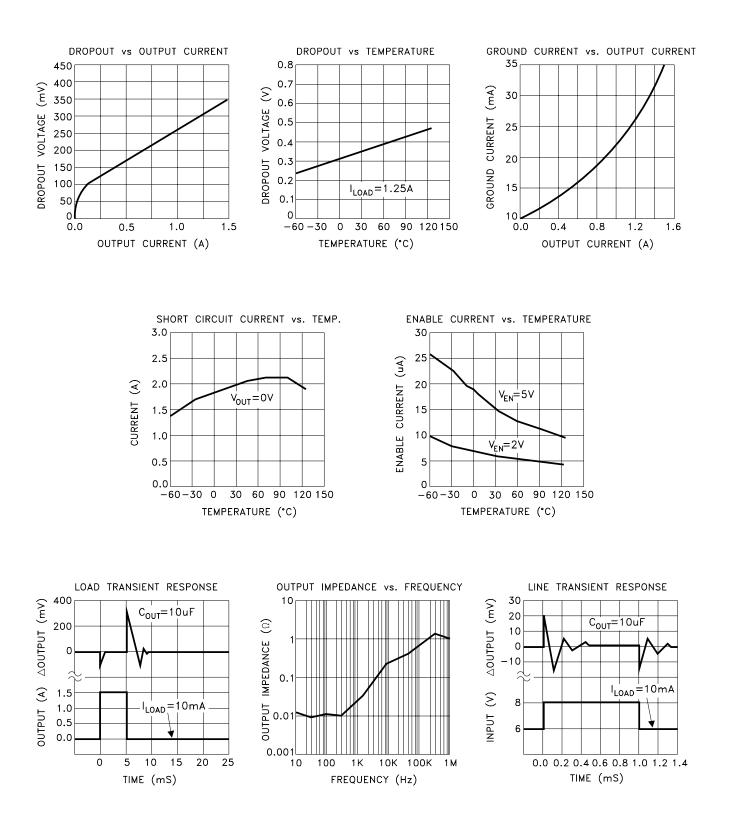
 $R\theta_{jc} = 3.6^{\circ}C/W$ and $R\theta_{cs} = 0.15^{\circ}C/W$ for most thermal greases Power Dissipation = (5V - 3.3V) x (1A) = 1.7 Watts

Solve for R0sa:

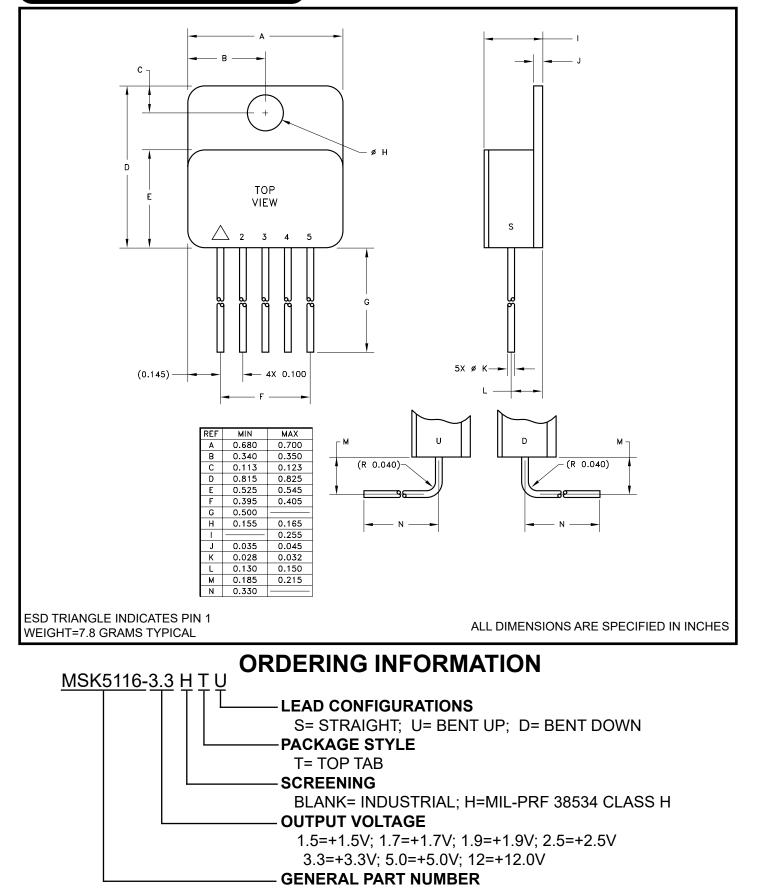
$$R\theta sa = \left[\frac{125^{\circ}C - 25^{\circ}C}{1.7W}\right] -3.6^{\circ}C/W - 0.15^{\circ}C/W$$
$$= 55.07^{\circ}C/W$$

In this example, a heat sink with a thermal resistance of no more than 55° C/W must be used to maintain a junction temperature of no more than 125° C.

TYPICAL PERFORMANCE CURVES

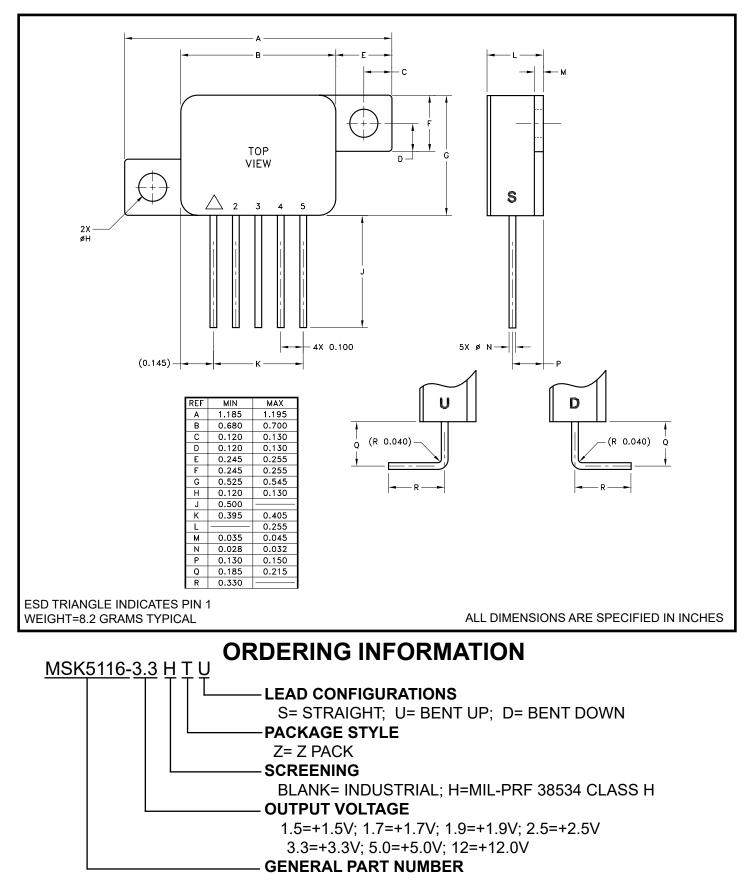


MECHANICAL SPECIFICATIONS



The above example is a +3.3V, Military regulator using the top tab package with leads bent up.

MECHANICAL SPECIFICATIONS CONT'D



The above example is a +3.3V, Military regulator using the top tab package with leads bent up.

REVISION HISTORY

REV	STATUS	DATE	DESCRIPTION	
С	Released	07/15	Add new note for solder, clarify mechanical specifications and add ESD rating	
D	Released	01/23	Remove MIL-PRF-38535 and update company name and website	

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